

Bias Resistor Transistor

PNP Silicon Surface Mount Transistor with Monolithic Bias Resistor Network

LDTA124XWT1G

- Applications

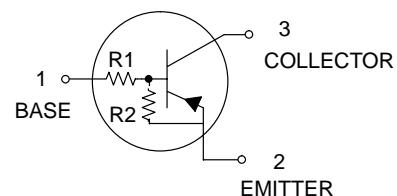
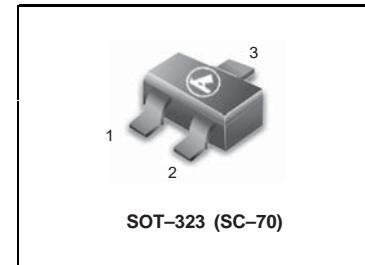
Inverter, Interface, Driver

- Features

- 1) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see equivalent circuit).
 - 2) The bias resistors consist of thin-film resistors with complete isolation to allow positive biasing of the input. They also have the advantage of almost completely eliminating parasitic effects.
 - 3) Only the on/off conditions need to be set for operation, making the device design easy.
- We declare that the material of product compliance with RoHS requirements.

- Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Supply voltage	V _{cc}	-50	V
Input voltage	V _i	-40 to +10	V
Output current	I _o	-20	mA
	I _{C(Max.)}	-100	
Power dissipation	P _D	150	mW
Junction temperature	T _j	150	°C
Storage temperature	T _{stg}	-55 to +150	°C



DEVICE MARKING AND RESISTOR VALUES

Device	Marking	R1 (K)	R2 (K)	Shipping
LDTA124XWT1G	6L	22	47	3000/Tape & Reel
LDTA124XWT3G	6L	22	47	10000/Tape & Reel

- Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Input voltage	V _{I(off)}	—	—	-0.5	V	V _{cc} = -5V, I _o = -100μA
	V _{I(on)}	-3	—	—		V _o = -0.3V, I _o = -1mA
Output voltage	V _{O(on)}	—	-0.1	-0.3	V	I _o = -5mA, I _i = -0.25mA
Input current	I _i	—	—	-0.15	mA	V _i = -5V
Output current	I _{O(off)}	—	—	-0.5	μA	V _{cc} = -50V, V _i =0V
DC current gain	G _i	82	—	—	—	I _o = -5mA, V _o = -5V
Input resistance	R _i	70	100	130	kΩ	—
Resistance ratio	R ₂ /R ₁	0.8	1	1.2	—	—
Transition frequency	f _T *	—	250	—	MHz	V _{ce} = -10V, I _E =5mA, f=100MHz

* Characteristics of built-in transistor

LDTA124XWT1G

●Electrical characteristic curves

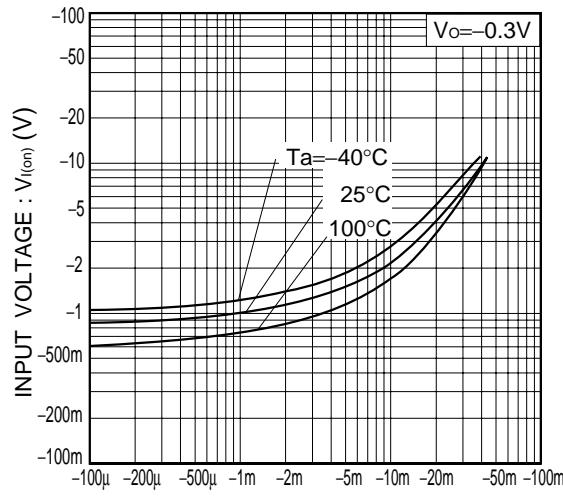


Fig.1 Input voltage vs. output current
(ON characteristics)

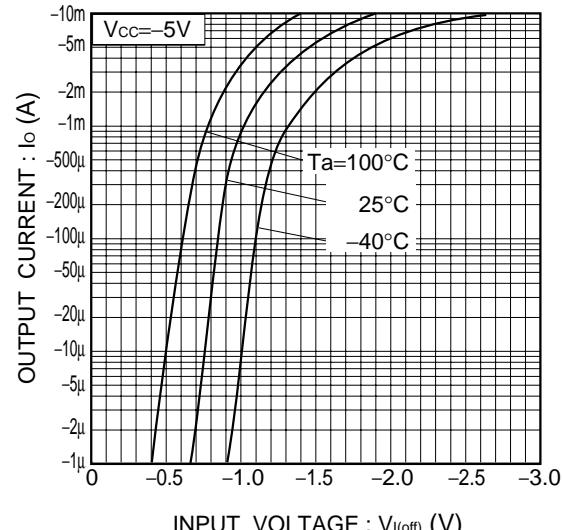


Fig.2 Output current vs. input voltage
(OFF characteristics)

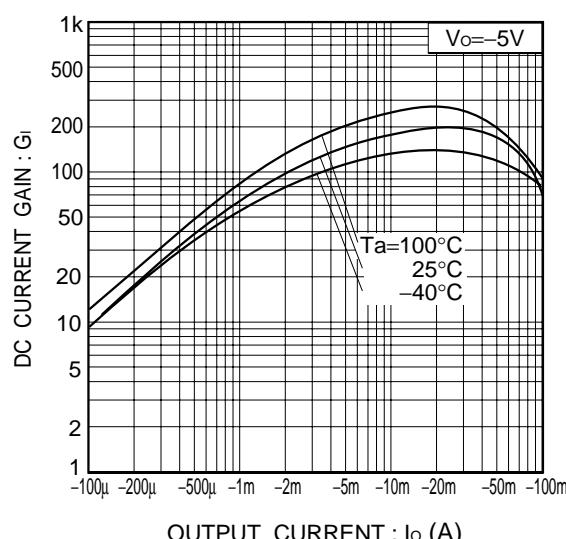


Fig.3 DC current gain vs. output current

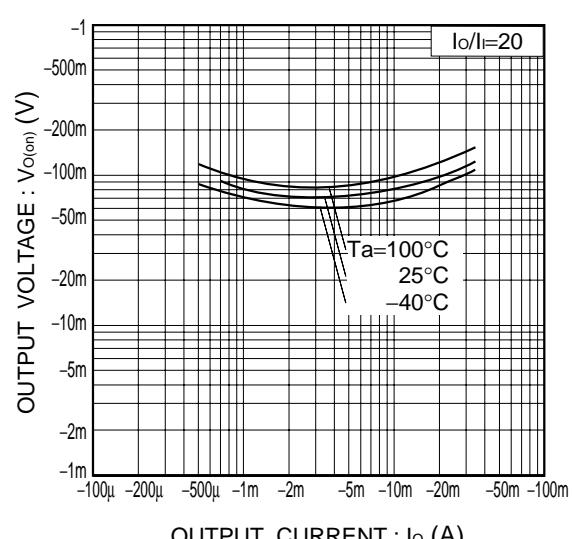
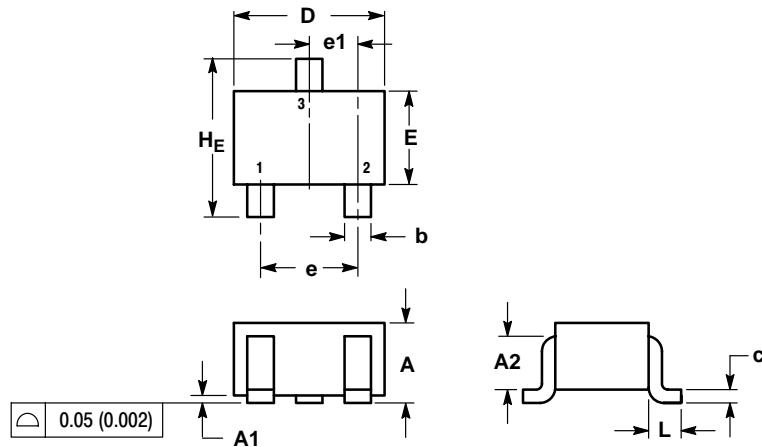
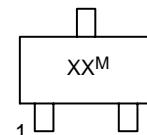


Fig.4 Output voltage vs. output current

LDTA124XWT1G
SC-70 (SOT-323)


NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.7	REF		0.028	REF	
b	0.30	0.35	0.40	0.012	0.014	0.016
c	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.10	2.20	0.071	0.083	0.087
E	1.15	1.24	1.35	0.045	0.049	0.053
e	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
L	0.425 REF			0.017 REF		
H_E	2.00	2.10	2.40	0.079	0.083	0.095

**GENERIC
MARKING DIAGRAM**


XX = Specific Device Code
 M = Date Code
 □ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking.
 Pb-Free indicator, "G" or microdot "■", may or may not be present.

SOLDERING FOOTPRINT*
